

TPS55340EVM-148, 8V to 24V Input, 5V Output Flyback Evaluation Module

This user's guide contains information for the TPS55340EVM-148 evaluation module (also called PWR148) as well as the TPS55340 DC/DC converter. The document includes the performance specifications, schematic, and the bill of materials for the TPS55340EVM-148.

Contents

1	Background	2
2	Performance Specification Summary	2
3	Modifications	2
4	Test Setup and Results	3
5	Board Layout	10
6	Schematic and Bill of Materials	12

List of Figures

1	Efficiency	5
2	Light-Load Efficiency	5
3	Output Voltage Load Regulation	5
4	Output Voltage Line Regulation	5
5	Load Transient Response	6
6	Loop Response.....	6
7	Maximum Load Output Voltage Ripple.....	7
8	DCM Output Voltage Ripple	7
9	Pulse-Skipping Output Voltage Ripple	7
10	Input Voltage Ripple	8
11	DCM Input Voltage Ripple	8
12	SW Pin Voltage Overshoot	8
13	Turn On With EN.....	9
14	Turn Off With EN.....	9
15	Turn On With V_{IN}	9
16	Turn Off With V_{IN}	9
17	Top-Side Assembly and Silk	10
18	Top-Side Layout	10
19	Internal Layer-1 Layout	11
20	Internal Layer-2 Layout	11
21	Bottom-Side Layout	11
22	Schematic	12

List of Tables

1	Input Voltage and Output Current Summary	2
2	Performance Specification Summary.....	2
3	EVM Connectors and Test Points	4
4	Bill of Materials.....	13

1 Background

The TPS55340 DC/DC Regulator is used typically in a boost topology, however this EVM demonstrates it in a flyback topology. Rated input voltage and output current range for the evaluation module are given in [Table 1](#). This evaluation module demonstrates the performance of the TPS55340 in an example application and can accommodate evaluation of other flyback applications supported by the TPS55340. The switching frequency is externally set at a nominal 350kHz. The 40V, 5A, low-side MOSFET is incorporated inside the TPS55340 package along with the gate-drive circuitry. The low drain-to-source on-resistance of the MOSFET allows the TPS55340 to achieve high efficiencies. The compensation components are external to the integrated circuit (IC). In this example application the absolute maximum input voltage for the TPS55340EVM-148 is 24V.

Table 1. Input Voltage and Output Current Summary

EVM	Input Voltage Range	Maximum Output Current
TPS55340EVM-148	$V_{IN} = 8V$ to 24V, 12V nominal	$I_{OUTmax} = 2.5A$

2 Performance Specification Summary

[Table 2](#) provides a summary of the TPS55340EVM-148 performance specifications. The ambient temperature is 25°C for all measurements, unless otherwise noted.

Table 2. Performance Specification Summary

Specification	Test Conditions	Min	Typ	Max	Unit
V_{IN} voltage range		8	12	24	V
No Load Input Current	$I_{OUT} = 0A$, $V_{IN} = 12V$		6.3		mA
Output voltage set point			5		V
Line regulation	$I_{OUT} = 2.5A$, $V_{IN} = 8V$ to 24V		± 0.1		%
Operating frequency			350		kHz
Output current range		.001		2.5	A
Output over current limit ⁽¹⁾	$V_{IN} = 8V$		3.4		A
Output over current limit ⁽¹⁾	$V_{IN} = 24V$		4.8		A
Load regulation	$I_{OUT} = 1mA$ to 2.5A, $V_{IN} = 8V$ to 24V		± 0.1		%
Load transient response	$I_{OUT} = 625mA$ to 1.875A, $V_{IN} = 12V$	Voltage change		-140	mV
		Recovery time		500	μs
	$I_{OUT} = 1.875mA$ to 625mA, $V_{IN} = 12V$	Voltage change		60	mV
		Recovery time		500	μs
Loop bandwidth	$I_{OUT} = 2.5A$, $V_{IN} = 12V$		7.8		kHz
Phase margin	$I_{OUT} = 2.5A$, $V_{IN} = 12V$		56		°
Output ripple voltage	$I_{OUT} = 2.5A$, $V_{IN} = 12V$		75		mVpp
Peak efficiency	$I_{OUT} = 0.9A$, $V_{IN} = 12V$		87.9		%
Output current DCM threshold	$V_{IN} = 12V$		340		mA

⁽¹⁾ The output over current limit is dependent on the input voltage and based on peak current limit of the TPS55340.

3 Modifications

These evaluation modules provide access to the features of the TPS55340 in a flyback topology. Modifications to this module are possible to support other flyback applications.

3.1 Output Voltage Set Point

The resistor divider network of R8 and R14 sets the output voltage. Keep R14 fixed at or close to 10k Ω . To change the output voltage of the EVM, change the value of resistor R8. Calculate the value of R8 for a specific output voltage by using [Equation 1](#) and the 1.24V V_{REF} of U3. For output voltages greater than 6V, it is recommended to use a TL431 for U3 with $V_{REF} = 2.495V$ and 36V maximum recommended output voltage.

$$R8 = R14 \times \left(\frac{V_{OUT}}{V_{REF}} - 1 \right) \quad (1)$$

Note that V_{IN} must be in a range so that the on-time is greater than the minimum controllable on-time (77ns typical), and the maximum duty cycle is less than 89% minimum and 93% typical. Additionally, for a flyback application it is recommended to limit the duty cycle to 50% max to reduce stress on external components and avoid sub-harmonic operation inherent to current mode control. The duty cycle in continuous-conduction mode (CCM) can be calculated with [Equation 2](#), where V_D is the forward voltage drop of the secondary Schottky diode (D1) and N is the primary to secondary turns ratio of the transformer.

$$D_{CCM} = \frac{(V_{OUT} + V_D) \times N}{V_{IN} + (V_{OUT} + V_D) \times N} \quad (2)$$

After adjusting the output voltage, the maximum input voltage must be taken into consideration. The voltage on the internal FET, the SW pin, is equal to the sum of the input voltage and the output voltage reflected through the transformer. Additional tolerance is recommended to accommodate ringing typical of a flyback supply. By using [Equation 3](#), you can estimate the voltage across the internal FET with a 20% tolerance. This must be less than the 40V absolute maximum rating.

$$V_{FET} = \frac{V_{IN \max} + (V_{OUT} + V_D) \times N}{0.8} \quad (3)$$

3.2 Maximum Output Current

After adjusting input or output voltage settings, verify the maximum output current per [Equation 4](#) below, where I_{LIM} is the peak current limit of the TPS55340, D_{max} is the CCM duty cycle with the minimum input voltage and η_{EST} is the estimated maximum load current efficiency.

$$I_{OUT \max} = \left(I_{LIM} - \frac{V_{IN \min} \times D_{max}}{2 \times L_{PRI} \times f_{SW}} \right) \times \frac{V_{IN \min} \times D_{max} \times \eta_{EST}}{V_{OUT}} \quad (4)$$

3.3 Soft-start Time

The primary soft-start time can be adjusted by changing the value of C12. The EVM uses $C12 = 0.1 \mu F$ to control the ramp of the COMP pin voltage. A larger capacitance increases the soft-start time while a smaller capacitance decreases it. Additionally C18 provides a soft-start for the secondary side reference based on the RC time constant of C18 and R6. The EVM uses $C18 = 1.0 \mu F$ to avoid any overshoot during start up. It is recommended to have the soft-start for the secondary side reference be longer than the primary side soft-start to avoid overshoot. A higher RC time constant increases the soft-start time while a lower RC time constant decreases it.

3.4 Other Modifications

When changing the switching frequency, input/output voltage range, transformer, output capacitors or compensation additional design changes may be needed. When making design changes it is recommended to replace the transformer with one optimized for the application's requirements for best performance.

4 Test Setup and Results

This section describes how to properly connect, set up, and use the TPS55340EVM-148 evaluation module. Included are test results typical for the evaluation module covering efficiency, output voltage regulation, load transients, loop response, output voltage ripple, input voltage ripple, start-up and shut-down. Measurements are for an ambient temperature of 25°C.

4.1 Input/Output Connections

The TPS55340EVM-148 is provided with input/output connectors and test points as shown in [Table 3](#). Connect a power supply capable of supplying 5A to J6 through a pair of 20 AWG wires. The jumper across JP1 in the ON position (1-2) must be in place. Connect the load to J7 through a pair of 20 AWG wires. The maximum load current capability must be at least 2.5A. Wire lengths must be minimized to reduce losses in the wires. Test point TP1 provides a place to monitor the V_{IN} input voltage with TP3 providing a convenient ground reference. Use TP2 to monitor the output voltage with TP4 as the ground reference.

Table 3. EVM Connectors and Test Points

Reference Designator	Function
J1	V_{IN} input voltage connector. (See Table 1 for V_{IN} range.)
J2	V_{OUT} output voltage connector
J3	2-pin header for primary side GND connections
J4	2-pin header for secondary side GND connections
J5	2-pin header for SYNC signal and GND connections
JP1	3-pin header for enable. Install jumper from pins 1-2 to enable or from pins 2-3 to disable.
TP1	V_{IN} test point
TP2	V_{OUT} test point
TP3	GND test point at V_{IN} connector
TP4	GND test point at V_{OUT} connector
TP5	SW test point
TP6	Test point between optocoupler, voltage divider network and output. Used for inner loop response measurements.
TP7	Test point between voltage divider network and output. Used for outer loop response measurements.
TP8	COMP test point

4.2 Efficiency

The efficiency of this EVM peaks at a load current of about 600mA at 8V input and 1.5A at 24V input, then decreases as the load current increases toward full load. Figure 1 shows the efficiency for the TPS55340EVM-148. Figure 2 shows the light-load efficiency by using a semi log scale.

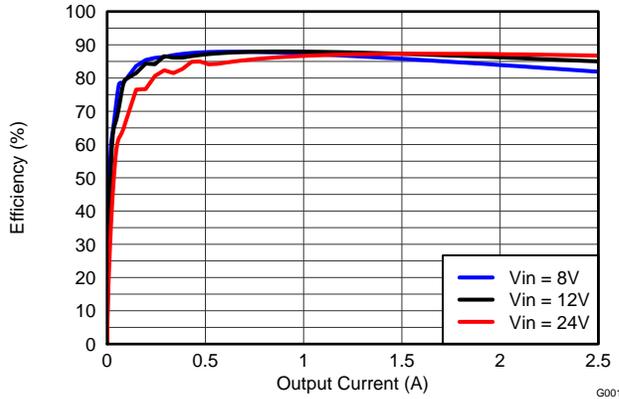


Figure 1. Efficiency

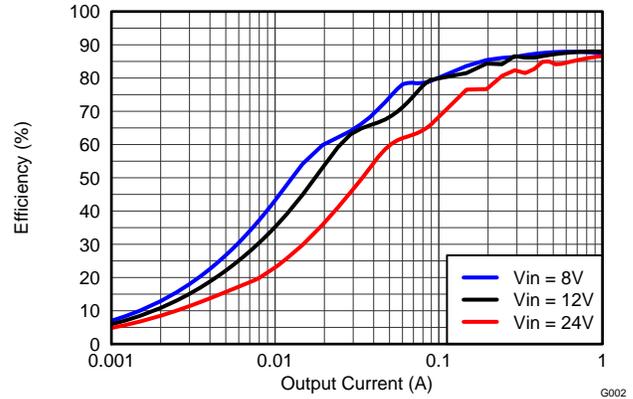


Figure 2. Light-Load Efficiency

The efficiency may be lower at higher ambient temperatures, due to temperature variation in the drain-to-source resistance of the internal MOSFET.

4.3 Output Voltage Line and Load Regulation

Figure 3 shows the load regulation for the TPS55340EVM-148. Figure 4 shows the line regulation for the TPS55340EVM-148 with a 2.5A load.

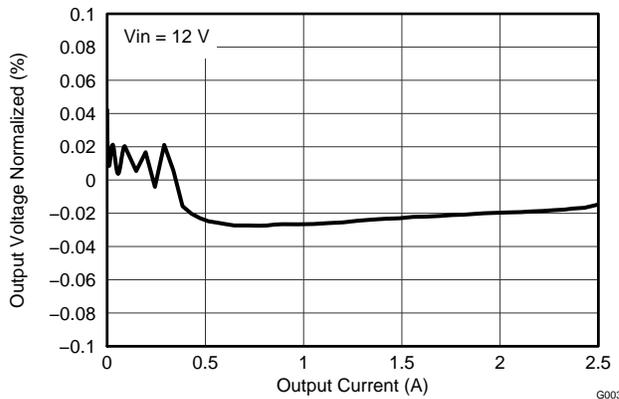


Figure 3. Output Voltage Load Regulation

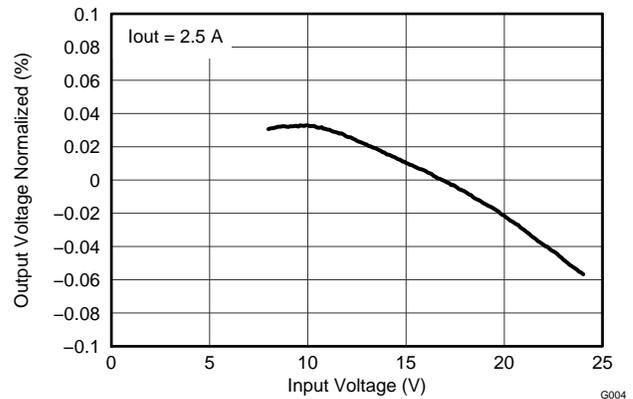


Figure 4. Output Voltage Line Regulation

4.4 Load Transient and Loop Response

Figure 5 show the TPS55340EVM-148 response to load transients. The current step is from 25% to 75% of maximum rated load at $V_{IN} = 12V$. The current step slew rate is $100 \text{ mA}/\mu\text{s}$. Total peak-to-peak voltage variation is as shown, including ripple and noise on the output.

Figure 6 shows the TPS55340EVM-148 loop-response characteristics. Gain and phase plots are shown for V_{IN} voltage of 12V with load current of 2.5A. The loop-response measurement is taken by replacing R3 with a 49.9- Ω resistor. The signal is then injected across it with test points TP2 and TP6.

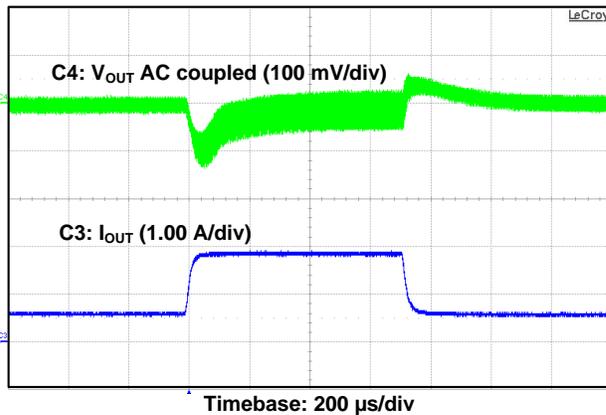


Figure 5. Load Transient Response

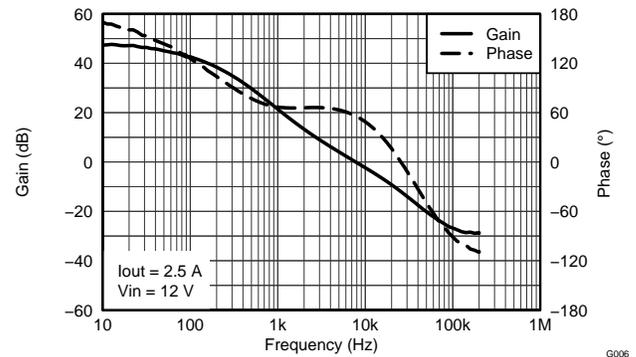


Figure 6. Loop Response

4.5 Output Voltage Ripple

Figure 7 shows the TPS55340EVM-148 output voltage ripple and switching waveform. The output current is the rated full load of 2.5A and $V_{IN} = 12V$. The ripple voltage is measured directly across C6.

Figure 8 shows the TPS55340EVM-148 output voltage ripple and switching waveform while operating in discontinuous conduction mode (DCM). The input voltage is 12V and the output is loaded with 20Ω (250mA).

The TPS55340 features pulse-skipping for output regulation when operating at light loads. Figure 9 shows the output voltage ripple and the pulse-skipping at SW. The input voltage is 24V and the output has no load.

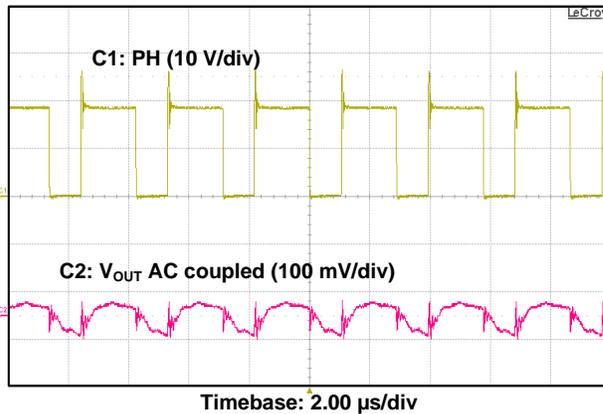


Figure 7. Maximum Load Output Voltage Ripple

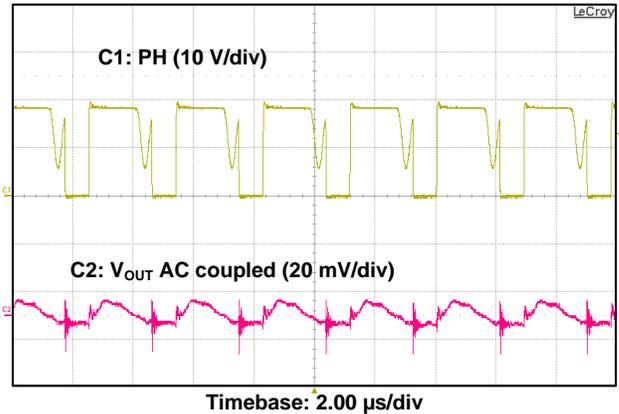


Figure 8. DCM Output Voltage Ripple

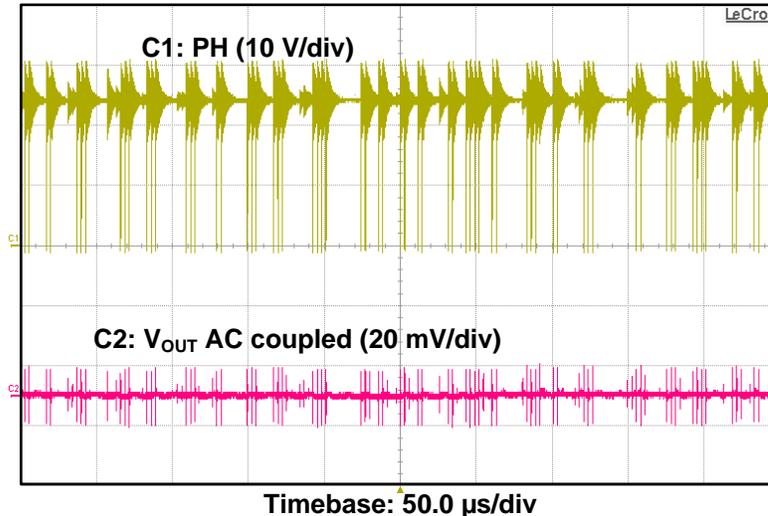
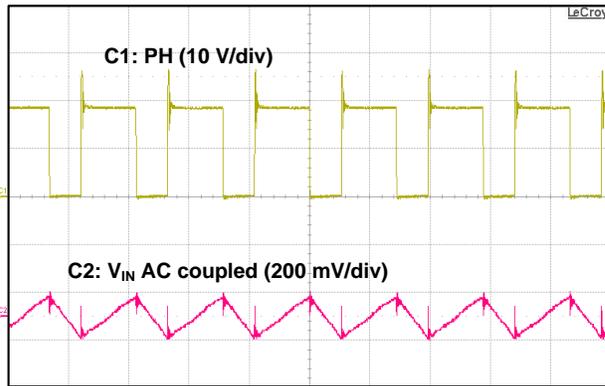


Figure 9. Pulse-Skipping Output Voltage Ripple

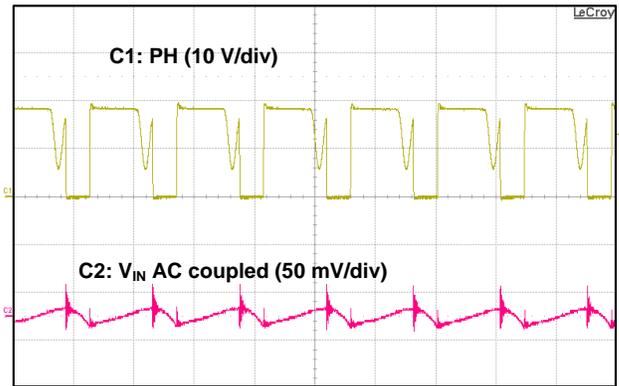
4.6 Input Voltage Ripple

Figure 10 shows the TPS55340EVM-148 input voltage ripple. The output current is the rated full load of 2.5A at $V_{IN} = 12V$. The ripple is measured directly across the input capacitor C2.

Figure 11 shows the TPS55340EVM-148 input voltage ripple operating in DCM. The input voltage is 12V and the output is loaded with 20Ω (250mA).



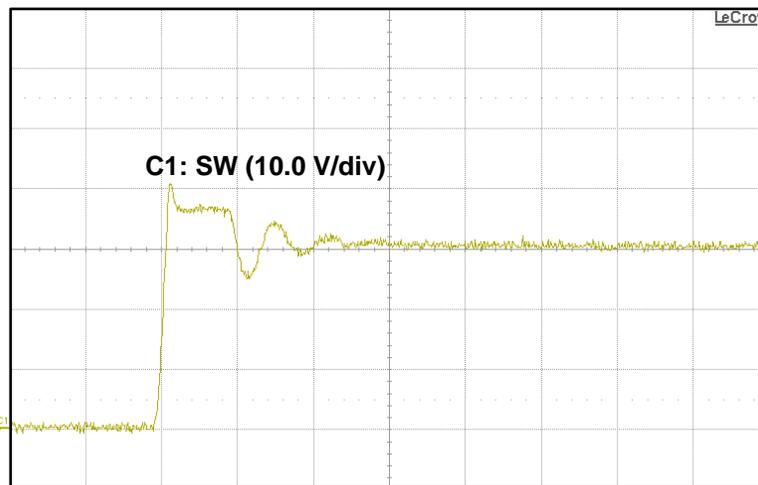
Timebase: 2.00 μs/div
Figure 10. Input Voltage Ripple



Timebase: 2.00 μs/div
Figure 11. DCM Input Voltage Ripple

4.7 Voltage Overshoot on SW Pin

Figure 12 shows the voltage overshoot on the SW pin with 200MHz bandwidth. This is measured with 24V input voltage and 2.5A output current.



Timebase: 50 ns/div
Figure 12. SW Pin Voltage Overshoot

4.8 Turn On and Off with EN

Figure 13 shows the start-up waveforms for the TPS55340EVM-148. The input voltage is 12V, the EN goes high, the COMP voltage rises, the device begins switching and the output voltage ramps from 0V to 5V. The load is 5Ω (1A).

Figure 14 shows the shutdown waveforms for the TPS55340EVM-148. The input voltage is 12V, the EN goes low and the output voltage ramps from 5V to 0V. The load is 5Ω (1A).

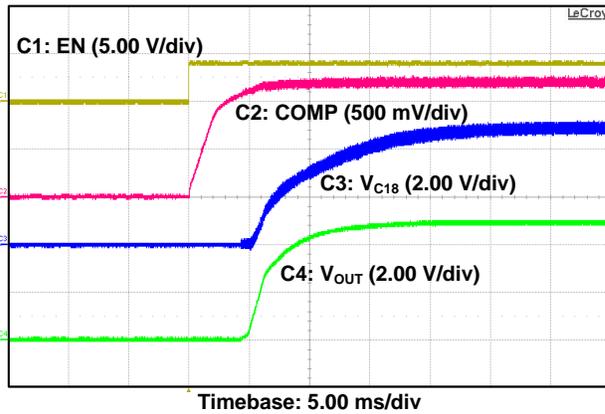


Figure 13. Turn On With EN

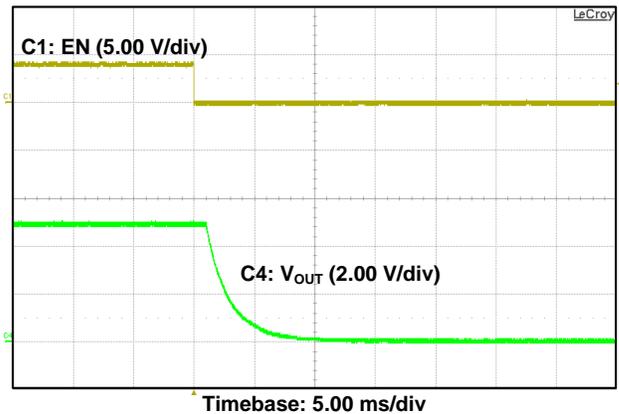


Figure 14. Turn Off With EN

4.9 Turn On and Off with V_{IN}

Figure 15 shows the start-up waveforms for the TPS55340EVM-148. The input voltage ramps with the input voltage power supply and EN is tied to V_{IN}. V_{IN} ramps up, the COMP voltage rises, the converter starts switching and the output voltage ramps to 5V. The load is 5Ω (1A).

Figure 16 shows the shutdown waveforms for the TPS55340EVM-148. The input voltage ramps down with the input voltage power supply and EN is tied to V_{IN}. When V_{IN} is less than the 2.5V typical UVLO, the converter stops switching and the output voltage ramps down. The load is 5Ω (1A).

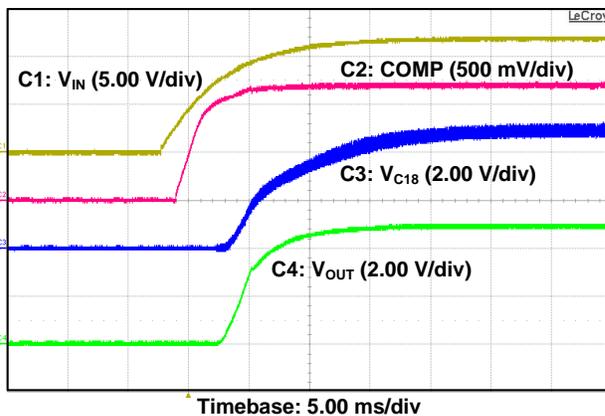


Figure 15. Turn On With V_{IN}

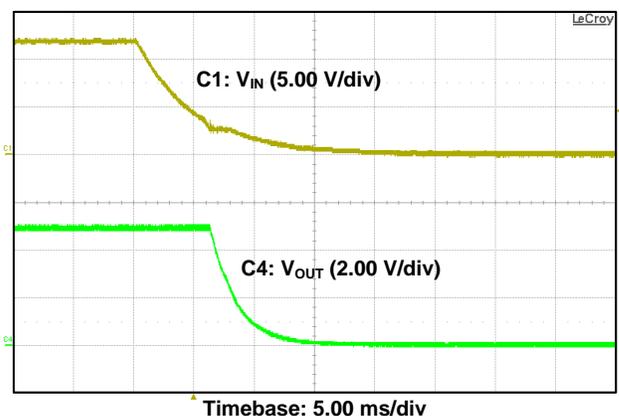


Figure 16. Turn Off With V_{IN}

5 Board Layout

This section provides a description of the TPS55340EVM-148 board layout and layer illustrations.

5.1 Layout

The board layout for the TPS55340EVM-148 is shown in [Figure 17](#) through [Figure 21](#). The top-side layer of the EVM is laid out in a manner typical of a user application. The top, bottom, and two internal layers are 2-oz copper.

The top layer contains the main power traces for V_{IN} , V_{OUT} , and SW. Also on the top layer are connections for the remaining pins of the TPS55340 and a large area filled with ground. The internal layers and bottom are primarily ground with additional fill areas for V_{IN} and V_{OUT} . The top-side ground traces connect to the bottom and internal ground planes with multiple vias placed around the board. Nine vias directly under the TPS55340 device provide a thermal path from the top-side ground plane to the bottom-side ground plane.

Place the output decoupling capacitors (C5-C8) next to D1 and the secondary winding of T1. The copper area of the SW node on the primary side is kept small to minimize noise. The vias near the diode, D1, on the V_{OUT} plane aid with thermal dissipation. Additionally, keep the voltage setpoint resistor divider components close to U3. The voltage divider network ties to the output voltage at the point of regulation, the copper V_{OUT} trace near TP2. For the TPS55340, an additional input bulk capacitor may be necessary, depending on the EVM connection to the input supply. Critical analog circuits such as the frequency set resistor, soft-start capacitor, and compensation components terminate to ground by using a separate ground trace on the top and bottom connected power ground pour only at one point directly under the IC.

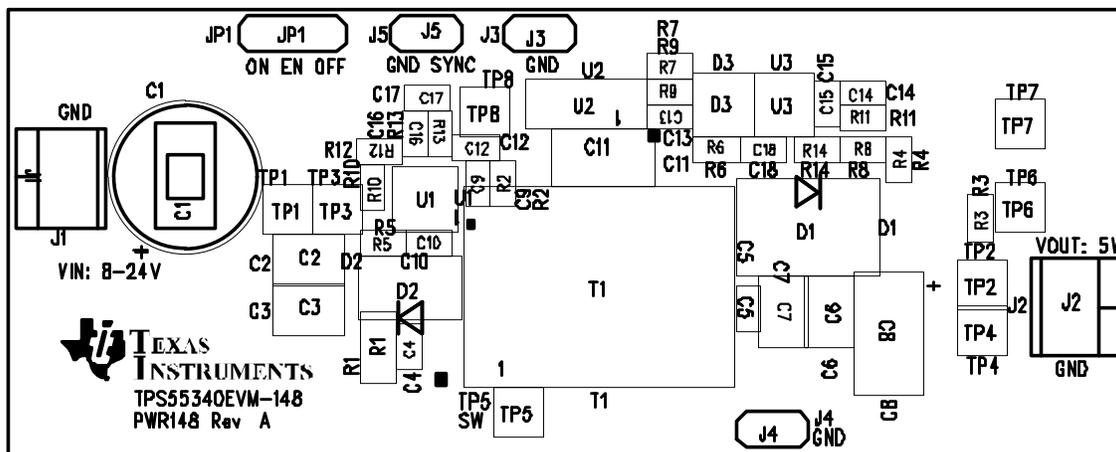


Figure 17. Top-Side Assembly and Silk

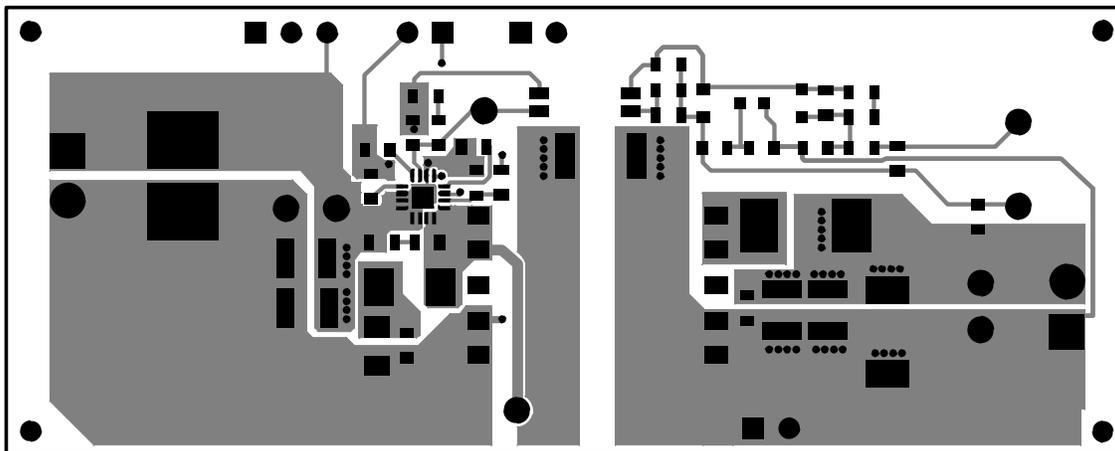


Figure 18. Top-Side Layout

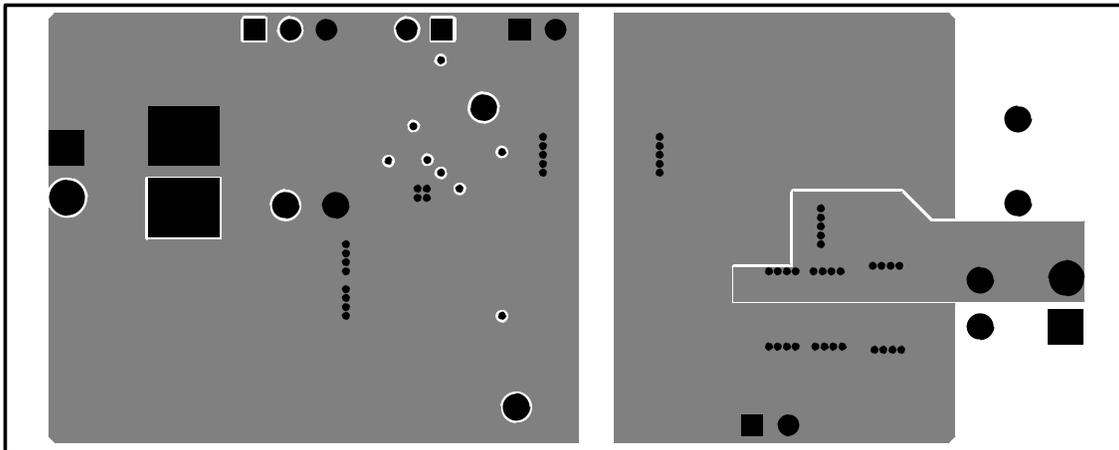


Figure 19. Internal Layer-1 Layout

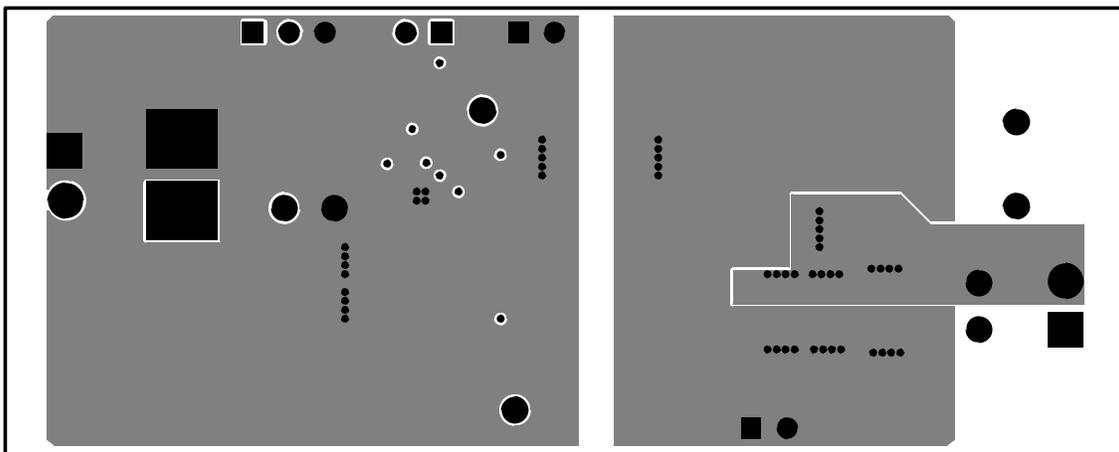


Figure 20. Internal Layer-2 Layout

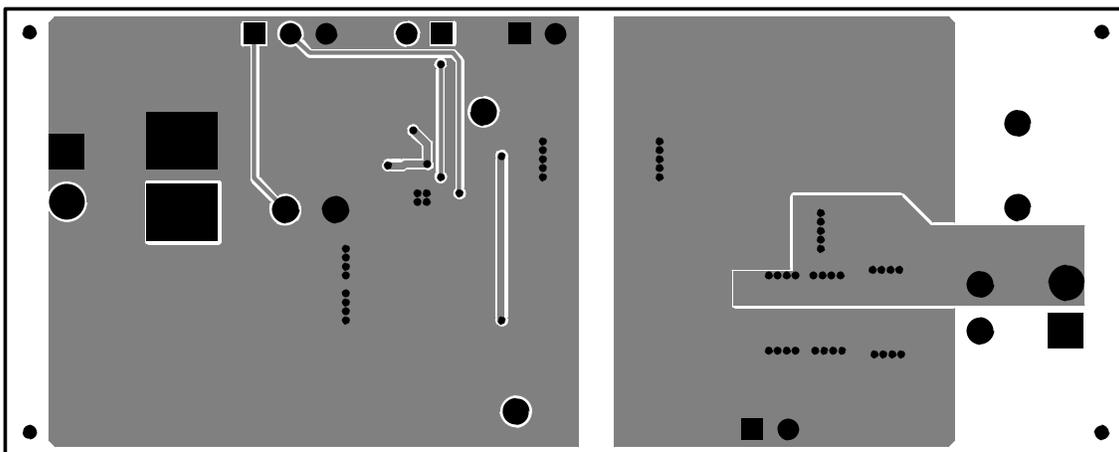


Figure 21. Bottom-Side Layout

6 Schematic and Bill of Materials

This section presents the TPS55340EVM-148 schematic and bill of materials.

6.1 Schematic

Figure 22 is the schematic for the TPS55340EVM-148.

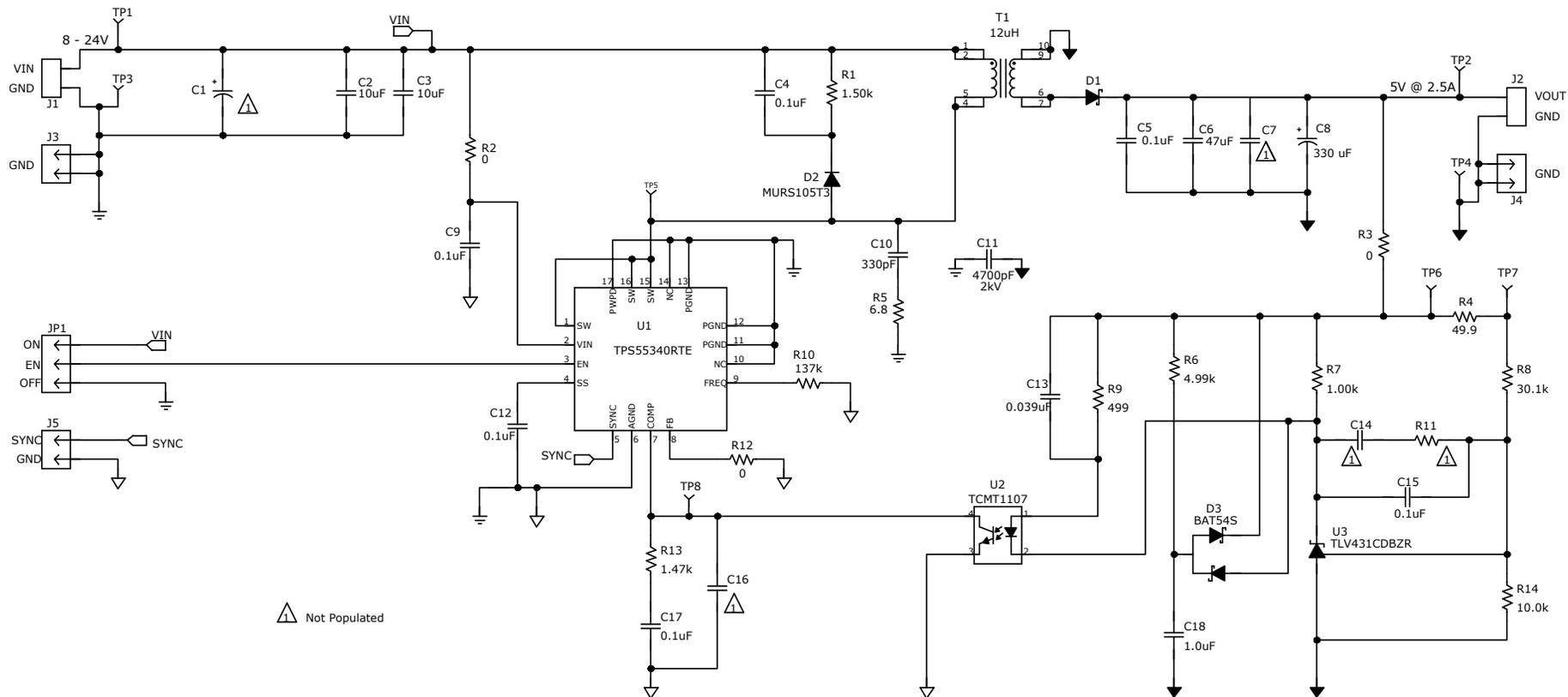


Figure 22. Schematic

6.2 Bill of Materials

Table 4 presents the bill of materials for the TPS55340EVM-148.

Table 4. Bill of Materials

COUNT	REFDES	VALUE	DESCRIPTION	SIZE	PART NUMBER	MFR
0	C1	Open	Capacitor	Multiple sizes	Engineering Only	Engineering Only
1	C6	47 μ F	Capacitor, ceramic, 10 V, X5R, 10%	1210	Std	Std
0	C7	Open	Capacitor, ceramic	1210	Std	Std
1	C8	330 μ F	Capacitor, low ESR, 10 V, \pm 20 %	D4	10TPE330M 6TPE330ML alt.	Sanyo
1	C10	330 pF	Capacitor, ceramic, 50 V, X7R, 10%	0603	Std	Std
1	C11	4700 pF	Capacitor, ceramic, 2 kV, X7R, 10%	1812	Std	Std
1	C13	0.039 μ F	Capacitor, ceramic, 50 V, X7R, 10%	0603	Std	Std
1	C18	1.0 μ F	Capacitor, ceramic, 16 V, X7R, 20%	0603	C1608X7R1C105M	TDK
4	C4, C9, C15, C17	0.1 μ F	Capacitor, ceramic, 50 V, X7R, 10%	0603	Std	Std
0	C14, C16	Open	Capacitor, ceramic	0603	Std	Std
2	C2-3	10 μ F	Capacitor, ceramic, 50 V, X5R, 10%	1210	Std	Std
2	C5, C12	0.1 μ F	Capacitor, ceramic, 10 V, X7R, 10%	0603	STD	STD
1	D1	MBRS340T3G	Diode, Schottky, 4 A, 40 V	SMC	MBRS340T3G	On Semi
1	D2	MURS105T3G	Diode, ultra-fast rectifier, 1 A, 50 V	SMB	MURS105T3G	On Semi
1	D3	BAT54STA	Diode, dual Schottky, 200 mA, 30 V	SOT23	BAT54STA	Zetex
2	J1-2	ED555/2DS	Terminal block, 2-pin, 6-A, 3.5mm	0.27 x 0.25 in	ED555/2DS	OST
3	J3-5	PEC02SAAN	Header, male 2-pin, 100 mil spacing	0.100 in x 2	PEC02SAAN	Sullins
1	JP1	PEC03SAAN	Header, male 3-pin, 100 mil spacing	0.100 in x 3	PEC03SAAN	Sullins
1	R1	1.50 k Ω	Resistor, thick film, 1/4 W, \pm 5%	1206	Std	Std
1	R3	0 Ω	Resistor, chip, 1/16 W, 1%	0603	Std	Std
1	R4	49.9 Ω	Resistor, chip, 1/16 W, 1%	0603	Std	Std
1	R5	6.8 Ω	Resistor, chip, 1/16 W, 1%	0603	STD	STD
1	R6	4.99 k Ω	Resistor, chip, 1/16 W, 1%	0603	Std	Std
1	R7	1.00 k Ω	Resistor, chip, 1/16 W, 1%	0603	Std	Std
1	R8	30.1 k Ω	Resistor, chip, 1/16 W, 1%	0603	Std	Std
1	R9	499 Ω	Resistor, chip, 1/16 W, 1%	0603	Std	Std
1	R10	137 k Ω	Resistor, chip, 1/16 W, 1%	0603	STD	STD
0	R11	Open	Resistor, chip, 1/16 W, 1%	0603	Std	Std
1	R13	1.47 k Ω	Resistor, chip, 1/16 W, 1%	0603	Std	Std
1	R14	10.0 k Ω	Resistor, chip, 1/16 W, 1%	0603	Std	Std
2	R2, R12	0 Ω	Resistor, chip, 1/16 W, 1%	0603	Std	Std
1	--		Shunt, 100-mil, black	0.100	929950-00	3M
1	T1	12 μ H	XFMR, 1.2 turns ratio	13.46 x 17.75 mm	NA5889-AL	Coilcraft
6	TP1-2, TP5-8	5000	Test point, red, thru hole color keyed	0.100 x 0.100 in	5000	Keystone
2	TP3-4	5001	Test point, black, thru hole color keyed	0.100 x 0.100 in	5001	Keystone
1	U1	TPS55340RTE	IC, 5-A high-voltage boost converter with soft-start and programmable switching frequency	QFN-16	TPS55340RTE	TI
1	U2	TCMT1107	IC, Photocoupler, CTR = 80% - 160%	MF4	TCMT1107	Vishay
1	U3	TLV431CDBZR	IC, Low-voltage adjustable shunt regulator	SOT23-3	TLV431CDBZR	TI
1	--		PCB, 3.125 In x 1.25 In x 0.062 In		PWR148	Any

Notes:

1. These assemblies are ESD sensitive, observe ESD precautions.
2. These assemblies must be clean and free from flux and all contaminants. Use of no-clean flux is not acceptable.
3. These assemblies must comply with workmanship standards IPC-A-610, Class 2.
4. Ref designators marked with an asterisk (***) cannot be substituted. All other components can be substituted with equivalent MFG's components.

6.3 Reference

1. *TPS55340, Integrated 5-A 40-V Boost/SEPIC/Flyback Converter with Adjustable Switching Frequency* data sheet ([SLVSB04](#))

EVALUATION BOARD/KIT/MODULE (EVM) ADDITIONAL TERMS

Texas Instruments (TI) provides the enclosed Evaluation Board/Kit/Module (EVM) under the following conditions:

The user assumes all responsibility and liability for proper and safe handling of the goods. Further, the user indemnifies TI from all claims arising from the handling or use of the goods.

Should this evaluation board/kit not meet the specifications indicated in the User's Guide, the board/kit may be returned within 30 days from the date of delivery for a full refund. THE FOREGOING LIMITED WARRANTY IS THE EXCLUSIVE WARRANTY MADE BY SELLER TO BUYER AND IS IN LIEU OF ALL OTHER WARRANTIES, EXPRESSED, IMPLIED, OR STATUTORY, INCLUDING ANY WARRANTY OF MERCHANTABILITY OR FITNESS FOR ANY PARTICULAR PURPOSE. EXCEPT TO THE EXTENT OF THE INDEMNITY SET FORTH ABOVE, NEITHER PARTY SHALL BE LIABLE TO THE OTHER FOR ANY INDIRECT, SPECIAL, INCIDENTAL, OR CONSEQUENTIAL DAMAGES.

Please read the User's Guide and, specifically, the Warnings and Restrictions notice in the User's Guide prior to handling the product. This notice contains important safety information about temperatures and voltages. For additional information on TI's environmental and/or safety programs, please visit www.ti.com/esh or contact TI.

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REGULATORY COMPLIANCE INFORMATION

As noted in the EVM User's Guide and/or EVM itself, this EVM and/or accompanying hardware may or may not be subject to the Federal Communications Commission (FCC) and Industry Canada (IC) rules.

For EVMs **not** subject to the above rules, this evaluation board/kit/module is intended for use for ENGINEERING DEVELOPMENT, DEMONSTRATION OR EVALUATION PURPOSES ONLY and is not considered by TI to be a finished end product fit for general consumer use. It generates, uses, and can radiate radio frequency energy and has not been tested for compliance with the limits of computing devices pursuant to part 15 of FCC or ICES-003 rules, which are designed to provide reasonable protection against radio frequency interference. Operation of the equipment may cause interference with radio communications, in which case the user at his own expense will be required to take whatever measures may be required to correct this interference.

General Statement for EVMs including a radio

User Power/Frequency Use Obligations: This radio is intended for development/professional use only in legally allocated frequency and power limits. Any use of radio frequencies and/or power availability of this EVM and its development application(s) must comply with local laws governing radio spectrum allocation and power limits for this evaluation module. It is the user's sole responsibility to only operate this radio in legally acceptable frequency space and within legally mandated power limitations. Any exceptions to this are strictly prohibited and unauthorized by Texas Instruments unless user has obtained appropriate experimental/development licenses from local regulatory authorities, which is responsibility of user including its acceptable authorization.

For EVMs annotated as FCC – FEDERAL COMMUNICATIONS COMMISSION Part 15 Compliant

Caution

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

FCC Interference Statement for Class A EVM devices

This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.

FCC Interference Statement for Class B EVM devices

This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

For EVMs annotated as IC – INDUSTRY CANADA Compliant

This Class A or B digital apparatus complies with Canadian ICES-003.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

Concerning EVMs including radio transmitters

This device complies with Industry Canada licence-exempt RSS standard(s). Operation is subject to the following two conditions: (1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

Concerning EVMs including detachable antennas

Under Industry Canada regulations, this radio transmitter may only operate using an antenna of a type and maximum (or lesser) gain approved for the transmitter by Industry Canada. To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (e.i.r.p.) is not more than that necessary for successful communication.

This radio transmitter has been approved by Industry Canada to operate with the antenna types listed in the user guide with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.

Cet appareil numérique de la classe A ou B est conforme à la norme NMB-003 du Canada.

Les changements ou les modifications pas expressément approuvés par la partie responsable de la conformité ont pu vider l'autorité de l'utilisateur pour actionner l'équipement.

Concernant les EVMs avec appareils radio

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes : (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

Concernant les EVMs avec antennes détachables

Conformément à la réglementation d'Industrie Canada, le présent émetteur radio peut fonctionner avec une antenne d'un type et d'un gain maximal (ou inférieur) approuvé pour l'émetteur par Industrie Canada. Dans le but de réduire les risques de brouillage radioélectrique à l'intention des autres utilisateurs, il faut choisir le type d'antenne et son gain de sorte que la puissance isotrope rayonnée équivalente (p.i.r.e.) ne dépasse pas l'intensité nécessaire à l'établissement d'une communication satisfaisante.

Le présent émetteur radio a été approuvé par Industrie Canada pour fonctionner avec les types d'antenne énumérés dans le manuel d'usage et ayant un gain admissible maximal et l'impédance requise pour chaque type d'antenne. Les types d'antenne non inclus dans cette liste, ou dont le gain est supérieur au gain maximal indiqué, sont strictement interdits pour l'exploitation de l'émetteur.

【Important Notice for Users of this Product in Japan】

This development kit is NOT certified as Confirming to Technical Regulations of Radio Law of Japan

If you use this product in Japan, you are required by Radio Law of Japan to follow the instructions below with respect to this product:

1. Use this product in a shielded room or any other test facility as defined in the notification #173 issued by Ministry of Internal Affairs and Communications on March 28, 2006, based on Sub-section 1.1 of Article 6 of the Ministry's Rule for Enforcement of Radio Law of Japan,
2. Use this product only after you obtained the license of Test Radio Station as provided in Radio Law of Japan with respect to this product, or
3. Use of this product only after you obtained the Technical Regulations Conformity Certification as provided in Radio Law of Japan with respect to this product. Also, please do not transfer this product, unless you give the same notice above to the transferee. Please note that if you could not follow the instructions above, you will be subject to penalties of Radio Law of Japan.

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EVALUATION BOARD/KIT/MODULE (EVM) WARNINGS, RESTRICTIONS AND DISCLAIMERS

For Feasibility Evaluation Only, in Laboratory/Development Environments. Unless otherwise indicated, this EVM is not a finished electrical equipment and not intended for consumer use. It is intended solely for use for preliminary feasibility evaluation in laboratory/development environments by technically qualified electronics experts who are familiar with the dangers and application risks associated with handling electrical mechanical components, systems and subsystems. It should not be used as all or part of a finished end product.

Your Sole Responsibility and Risk. You acknowledge, represent and agree that:

1. You have unique knowledge concerning Federal, State and local regulatory requirements (including but not limited to Food and Drug Administration regulations, if applicable) which relate to your products and which relate to your use (and/or that of your employees, affiliates, contractors or designees) of the EVM for evaluation, testing and other purposes.
2. You have full and exclusive responsibility to assure the safety and compliance of your products with all such laws and other applicable regulatory requirements, and also to assure the safety of any activities to be conducted by you and/or your employees, affiliates, contractors or designees, using the EVM. Further, you are responsible to assure that any interfaces (electronic and/or mechanical) between the EVM and any human body are designed with suitable isolation and means to safely limit accessible leakage currents to minimize the risk of electrical shock hazard.
3. You will employ reasonable safeguards to ensure that your use of the EVM will not result in any property damage, injury or death, even if the EVM should fail to perform as described or expected.
4. You will take care of proper disposal and recycling of the EVM's electronic components and packing materials.

Certain Instructions. It is important to operate this EVM within TI's recommended specifications and environmental considerations per the user guidelines. Exceeding the specified EVM ratings (including but not limited to input and output voltage, current, power, and environmental ranges) may cause property damage, personal injury or death. If there are questions concerning these ratings please contact a TI field representative prior to connecting interface electronics including input power and intended loads. Any loads applied outside of the specified output range may result in unintended and/or inaccurate operation and/or possible permanent damage to the EVM and/or interface electronics. Please consult the EVM User's Guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative. During normal operation, some circuit components may have case temperatures greater than 60°C as long as the input and output are maintained at a normal ambient operating temperature. These components include but are not limited to linear regulators, switching transistors, pass transistors, and current sense resistors which can be identified using the EVM schematic located in the EVM User's Guide. When placing measurement probes near these devices during normal operation, please be aware that these devices may be very warm to the touch. As with all electronic evaluation tools, only qualified personnel knowledgeable in electronic measurement and diagnostics normally found in development environments should use these EVMs.

Agreement to Defend, Indemnify and Hold Harmless. You agree to defend, indemnify and hold TI, its licensors and their representatives harmless from and against any and all claims, damages, losses, expenses, costs and liabilities (collectively, "Claims") arising out of or in connection with any use of the EVM that is not in accordance with the terms of the agreement. This obligation shall apply whether Claims arise under law of tort or contract or any other legal theory, and even if the EVM fails to perform as described or expected.

Safety-Critical or Life-Critical Applications. If you intend to evaluate the components for possible use in safety critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, such as devices which are classified as FDA Class III or similar classification, then you must specifically notify TI of such intent and enter into a separate Assurance and Indemnity Agreement.

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TI has specifically designated certain components as meeting ISO/TS16949 requirements, mainly for automotive use. In any case of use of non-designated products, TI will not be responsible for any failure to meet ISO/TS16949.

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